

SN54ALS109A, SN54AS109A, SN74ALS109A, SN74AS109A DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS WITH CLEAR AND PRESET

SDAS198B – APRIL 1982 – REVISED AUGUST 1995

- Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

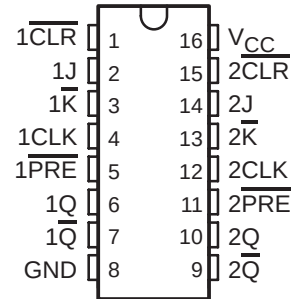
TYPE	TYPICAL MAXIMUM CLOCK FREQUENCY (MHz)	TYPICAL POWER DISSIPATION PER FLIP-FLOP (mW)
'ALS109A	50	6
'AS109A	129	29

description

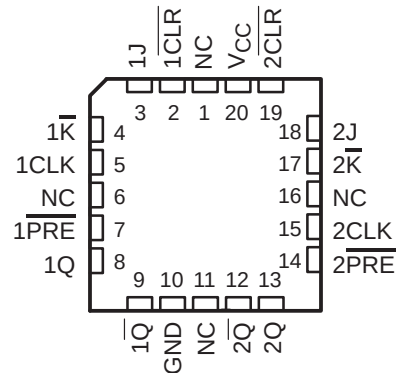
These devices contain two independent J-K positive-edge-triggered flip-flops. A low level at the preset ($\overline{\text{PRE}}$) or clear ($\overline{\text{CLR}}$) inputs sets or resets the outputs regardless of the levels of the other inputs. When $\overline{\text{PRE}}$ and $\overline{\text{CLR}}$ are inactive (high), data at the J and $\overline{\text{K}}$ inputs meeting the setup-time requirements are transferred to the outputs on the positive-going edge of the clock (CLK) pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the J and $\overline{\text{K}}$ inputs can be changed without affecting the levels at the outputs. These versatile flip-flops can perform as toggle flip-flops by grounding $\overline{\text{K}}$ and tying J high. They also can perform as D-type flip-flops if J and $\overline{\text{K}}$ are tied together.

The SN54ALS109A and SN54AS109A are characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ALS109A and SN74AS109A are characterized for operation from 0°C to 70°C .

SN54ALS109A, SN54AS109A ... J PACKAGE
SN74ALS109A, SN74AS109A ... D OR N PACKAGE
(TOP VIEW)



SN54ALS109A, SN54AS109A ... FK PACKAGE
(TOP VIEW)



NC – No internal connection

FUNCTION TABLE

INPUTS					OUTPUTS	
$\overline{\text{PRE}}$	$\overline{\text{CLR}}$	CLK	J	$\overline{\text{K}}$	Q	$\overline{\text{Q}}$
L	H	X	X	X	H	L
H	L	X	X	X	L	H
L	L	X	X	X	$\text{H}^{\dagger}$	$\text{H}^{\dagger}$
H	H	$\uparrow$	L	L	L	H
H	H	$\uparrow$	H	L	Toggle	
H	H	$\uparrow$	L	H	Q0	$\overline{\text{Q}}0$
H	H	$\uparrow$	H	H	H	L
H	H	L	X	X	Q0	$\overline{\text{Q}}0$

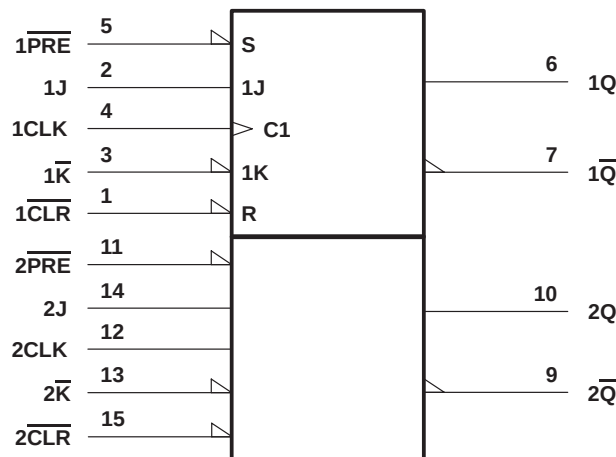
$\dagger$ The output levels in this configuration are not specified to meet the minimum levels for V_{OH} if the lows at $\overline{\text{PRE}}$ and $\overline{\text{CLR}}$ are near V_{IL} maximum. Furthermore, this configuration is nonstable; that is, it does not persist when either $\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ returns to its inactive (high) level.

SN54ALS109A, SN54AS109A, SN74ALS109A, SN74AS109A

DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS WITH CLEAR AND PRESET

SDAS198B – APRIL 1982 – REVISED AUGUST 1995

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, J, and N packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V_{CC}	7 V
Input voltage, V_I	7 V
Operating free-air temperature range, T_A : SN54ALS109A	–55°C to 125°C
SN74ALS109A	0°C to 70°C
Storage temperature range	–65°C to 150°C

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

			SN54ALS109A			SN74ALS109A			UNIT		
			MIN	NOM	MAX	MIN	NOM	MAX			
V _{CC}	Supply voltage		4.5	5	5.5	4.5	5	5.5	V		
V _{IH}	High-level input voltage		2			2			V		
V _{IL}	Low-level input voltage		0.7			0.8			V		
I _{OH}	High-level output current		−0.4			−0.4			mA		
I _{OL}	Low-level output current		4			8			mA		
f _{clock}	Clock frequency		0	30		0	34		MHz		
t _w	Pulse duration	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ low	15			15			ns		
		CLK high	16.5			14.5					
		CLK low	16.5			14.5					
t _{su}	Setup time before CLK↑	Data	15			15			ns		
		$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ inactive	10			10					
t _h	Hold time after CLK↑	Data	0			0			ns		
T _A	Operating free-air temperature		−55			125			0	70	°C

SN54ALS109A, SN54AS109A, SN74ALS109A, SN74AS109A

DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS

WITH CLEAR AND PRESET

SDAS198B – APRIL 1982 – REVISED AUGUST 1995

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	SN54ALS109A			SN74ALS109A			UNIT
			MIN	TYP†	MAX	MIN	TYP†	MAX	
V _{IK}		V _{CC} = 4.5 V, I _I = -18 mA	-1.5			-1.5			V
V _{OH}		V _{CC} = 4.5 V to 5.5 V, I _{OH} = -0.4 mA	V _{CC} -2			V _{CC} -2			V
V _{OL}		V _{CC} = 4.5 V	I _{OL} = 4 mA			0.25 0.4			V
			I _{OL} = 8 mA			0.35 0.5			
I _I	CLK, J, or $\overline{K}$	V _{CC} = 5.5 V, V _I = 7 V	0.1			0.1			mA
	$\overline{PRE}$ or $\overline{CLR}$		0.2			0.2			
I _{IH}	CLK, J, or $\overline{K}$	V _{CC} = 5.5 V, V _I = 2.7 V	20			20			μA
	$\overline{PRE}$ or $\overline{CLR}$		40			40			
I _{IL}	CLK, J, or $\overline{K}$	V _{CC} = 5.5 V, V _I = 0.4 V	-0.2			-0.2			mA
	$\overline{PRE}$ or $\overline{CLR}$		-0.4			-0.4			
I _O ‡		V _{CC} = 5.5 V, V _O = 2.25 V	-20		-112	-30		-112	mA
I _{CC}		V _{CC} = 5.5 V, See Note 1	2.4		4	2.4		4	mA

† All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS} .

NOTE 1: I_{CC} is measured with J, K, CLK, and PRE grounded, then with J, K, CLK, and CLR grounded.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R _L = 500 Ω, T _A = MIN to MAX [§]				UNIT
			SN54ALS109A		SN74ALS109A		
			MIN	MAX	MIN	MAX	
f _{max}			30		34		MHz
t _{PLH}	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or $\overline{\text{Q}}$	3	17	3	13	ns
t _{PHL}			5	17	5	15	
t _{PLH}	CLK	Q or $\overline{\text{Q}}$	5	21	5	16	ns
t _{PHL}			5	20	5	18	

§ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



SN54ALS109A, SN54AS109A, SN74ALS109A, SN74AS109A

DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS

WITH CLEAR AND PRESET

SDAS198B – APRIL 1982 – REVISED AUGUST 1995

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V_{CC}	7 V
Input voltage, V_I	7 V
Operating free-air temperature range, T_A : SN54AS109A	–55°C to 125°C
SN74AS109A	0°C to 70°C
Storage temperature range	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

			SN54AS109A			SN74AS109A			UNIT		
			MIN	NOM	MAX	MIN	NOM	MAX			
V _{CC}	Supply voltage		4.5	5	5.5	4.5	5	5.5	V		
V _{IH}	High-level input voltage		2			2			V		
V _{IL}	Low-level input voltage		0.8			0.8			V		
I _{OH}	High-level output current		−2			−2			mA		
I _{OL}	Low-level output current		20			20			mA		
f _{clock} *	Clock frequency		0	90		0	105		MHz		
t _w *	Pulse duration	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ low	4			4			ns		
		CLK high	4			4					
		CLK low	5.5			5.5					
t _{su} *	Setup time before CLK↑	Data	5.5			5.5			ns		
		$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ inactive	2			2					
t _h *	Hold time after CLK↑	Data	0			0			ns		
T _A	Operating free-air temperature		−55			125			0	70	°C

* On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data but is not production tested.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54AS109A			SN74AS109A			UNIT
				MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V_{IK}		$V_{CC} = 4.5\text{ V}$, $I_I = -18\text{ mA}$				–1.2			–1.2	V
V_{OH}		$V_{CC} = 4.5\text{ V to } 5.5\text{ V}$, $I_{OH} = -2\text{ mA}$		$V_{CC}-2$			$V_{CC}-2$			V
V_{OL}		$V_{CC} = 4.5\text{ V}$, $I_{OL} = 20\text{ mA}$			0.25	0.5		0.25	0.5	V
I_I		$V_{CC} = 5.5\text{ V}$, $V_I = 7\text{ V}$				0.1			0.1	mA
I_{IH}	CLK, J, or $\overline{K}$	$V_{CC} = 5.5\text{ V}$, $V_I = 2.7\text{ V}$				20			20	μA
	$\overline{PRE}$ or $\overline{CLR}$					40			40	
I_{IL}	CLK, J, or $\overline{K}$	$V_{CC} = 5.5\text{ V}$, $V_I = 0.4\text{ V}$				–0.5			–0.5	mA
	$\overline{PRE}$ or $\overline{CLR}$					–1.8			–1.8	
$I_O^{\S}$		$V_{CC} = 5.5\text{ V}$, $V_O = 2.25\text{ V}$		–30		–112	–30		–112	mA
I_{CC}		$V_{CC} = 5.5\text{ V}$, See Note 1			11.5	17		11.5	17	mA

[‡] All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

^{\S} The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS} .

NOTE 1: I_{CC} is measured with J, K, CLK, and $\overline{PRE}$ grounded, then with J, K, CLK, and $\overline{CLR}$ grounded.

SN54ALS109A, SN54AS109A, SN74ALS109A, SN74AS109A

DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS

WITH CLEAR AND PRESET

SDAS198B – APRIL 1982 – REVISED AUGUST 1995

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R _L = 500 Ω, T _A = MIN to MAX†				UNIT
			SN54AS109A		SN74AS109A		
			MIN	MAX	MIN	MAX	
f _{max} *			90		105		MHz
t _{PLH}	PRE or CLR	Q or Q̄	2	9	2	8	ns
t _{PHL}			3.5	11.5	3.5	10.5	
t _{PLH}	CLK	Q or Q̄	2.5	10	2.5	9	ns
t _{PHL}			3.5	10.5	3.5	9	

* On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data but is not production tested.

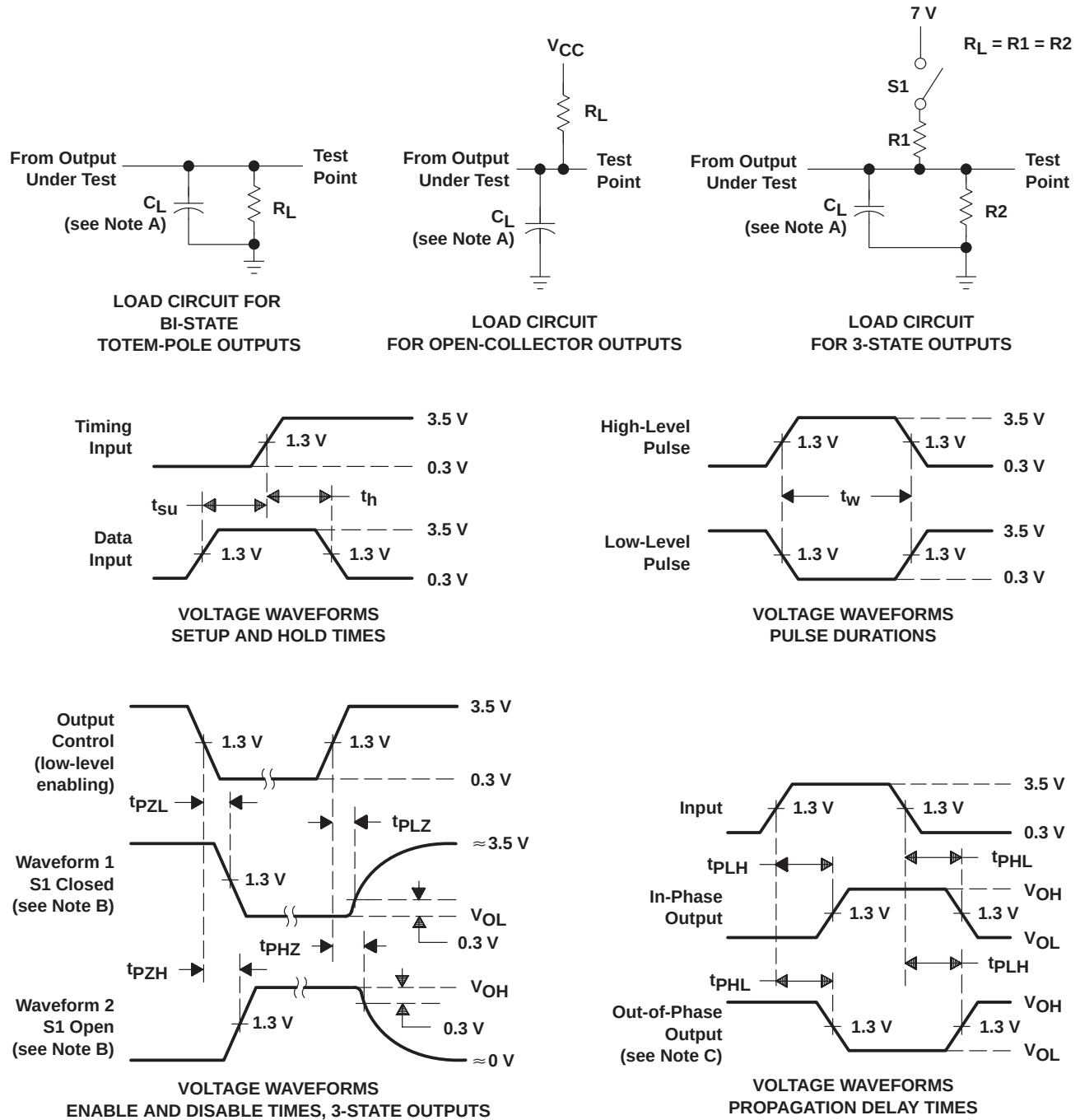
† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



SN54ALS109A, SN54AS109A, SN74ALS109A, SN74AS109A DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS WITH CLEAR AND PRESET

SDAS198B – APRIL 1982 – REVISED AUGUST 1995

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
 D. All input pulses have the following characteristics: $PRR \leq 1$ MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
 E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
84000012A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	84000012A SNJ54ALS 109AFK	Samples
8400001EA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8400001EA SNJ54ALS109AJ	Samples
JM38510/37102B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 37102B2A	Samples
JM38510/37102BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 37102BEA	Samples
M38510/37102B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 37102B2A	Samples
M38510/37102BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 37102BEA	Samples
SN54ALS109AJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54ALS109AJ	Samples
SN74ALS109AD	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS109A	Samples
SN74ALS109ADG4	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS109A	Samples
SN74ALS109AN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS109AN	Samples
SN74ALS109ANSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS109A	Samples
SN74AS109AD	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS109A	Samples
SN74AS109AN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74AS109AN	Samples
SN74AS109ANSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74AS109A	Samples
SNJ54ALS109AFK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	84000012A SNJ54ALS 109AFK	Samples
SNJ54ALS109AJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8400001EA SNJ54ALS109AJ	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of ≤ 1000 ppm threshold. Antimony trioxide based flame retardants must also meet the ≤ 1000 ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54ALS109A, SN74ALS109A :

- Catalog : [SN74ALS109A](#)

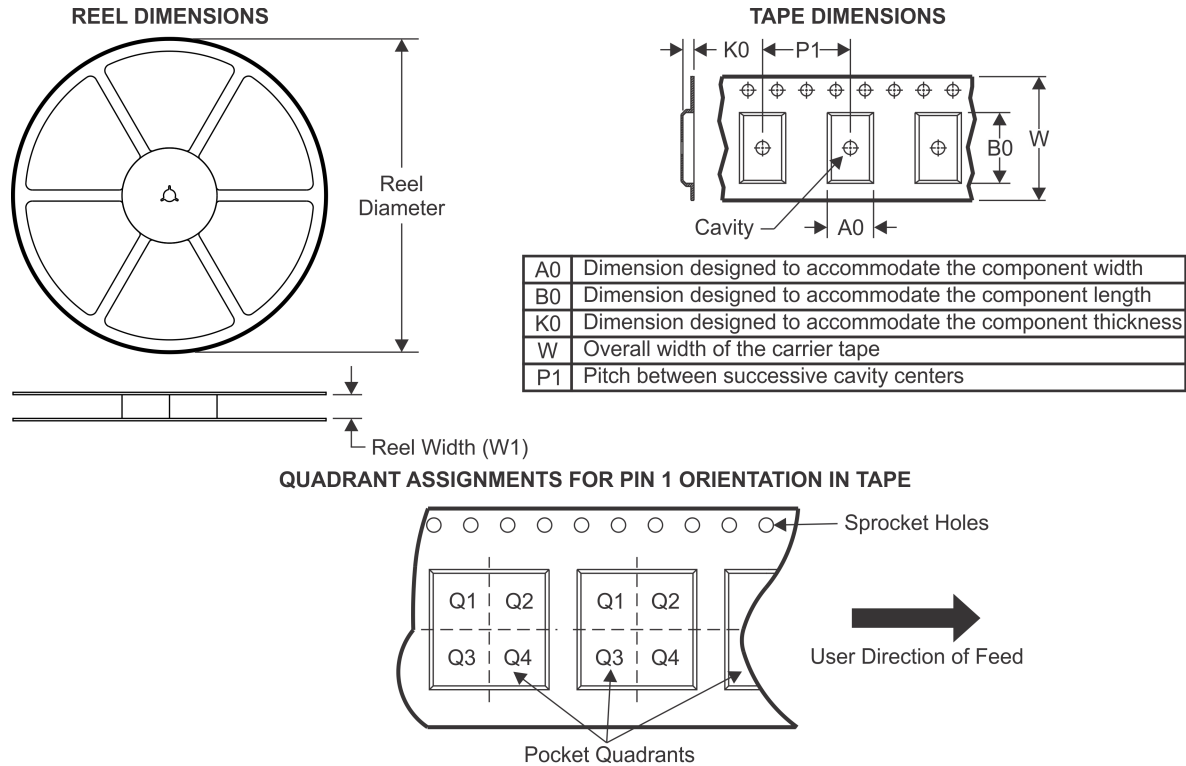
- Military : [SN54ALS109A](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

- Military - QML certified for Military and Defense Applications

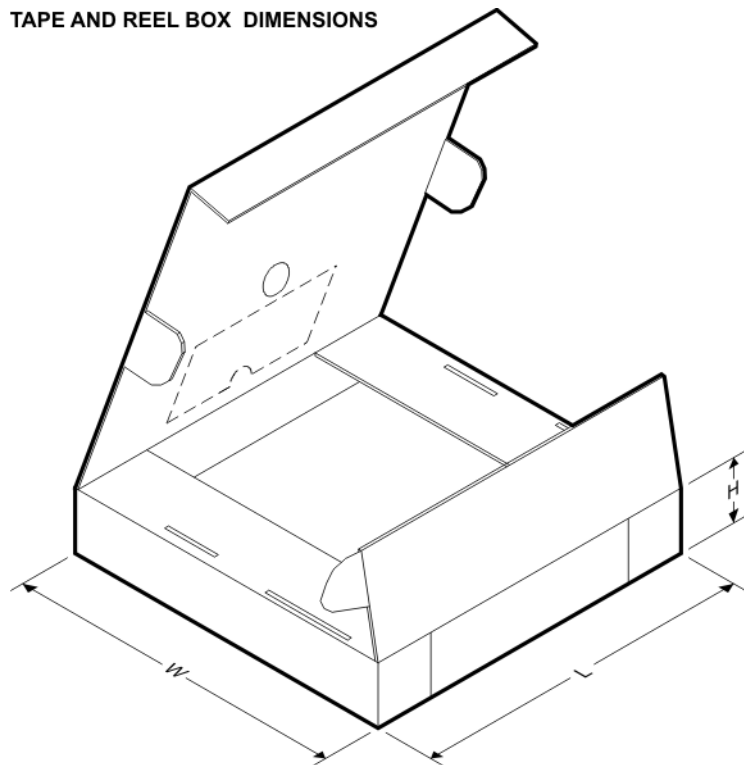
TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS109ANSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74AS109ANSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

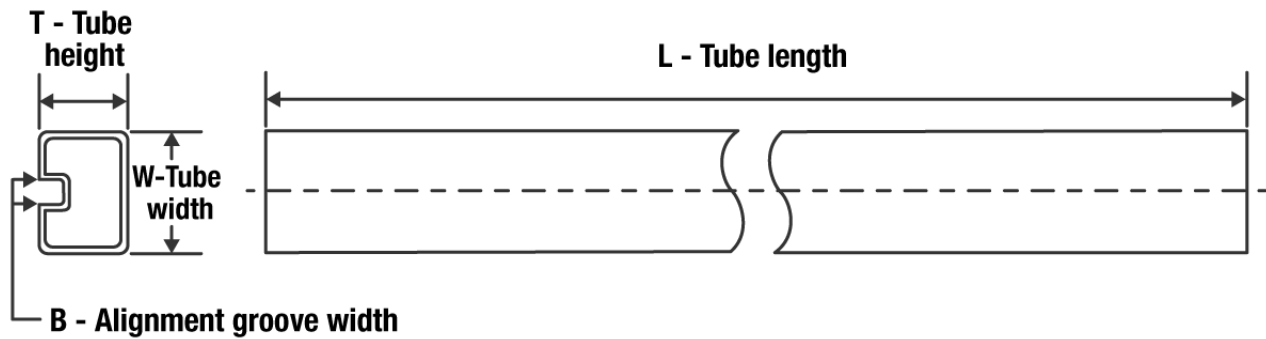
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS109ANSR	SO	NS	16	2000	853.0	449.0	35.0
SN74AS109ANSR	SO	NS	16	2000	853.0	449.0	35.0

TUBE



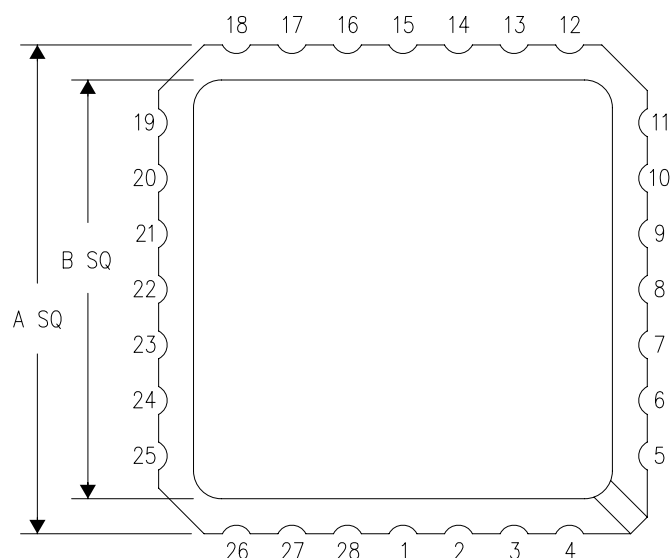
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
84000012A	FK	LCCC	20	1	506.98	12.06	2030	NA
JM38510/37102B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
M38510/37102B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
SN74ALS109AD	D	SOIC	16	40	507	8	3940	4.32
SN74ALS109ADG4	D	SOIC	16	40	507	8	3940	4.32
SN74ALS109AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74ALS109AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS109AD	D	SOIC	16	40	507	8	3940	4.32
SN74AS109AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS109AN	N	PDIP	16	25	506	13.97	11230	4.32
SNJ54ALS109AFK	FK	LCCC	20	1	506.98	12.06	2030	NA

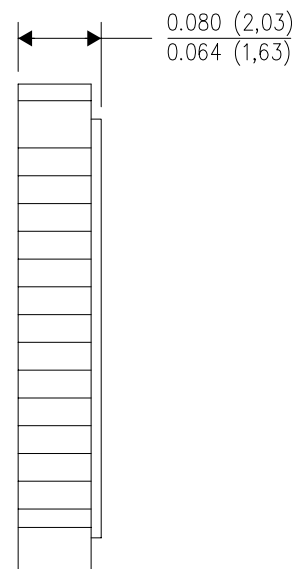
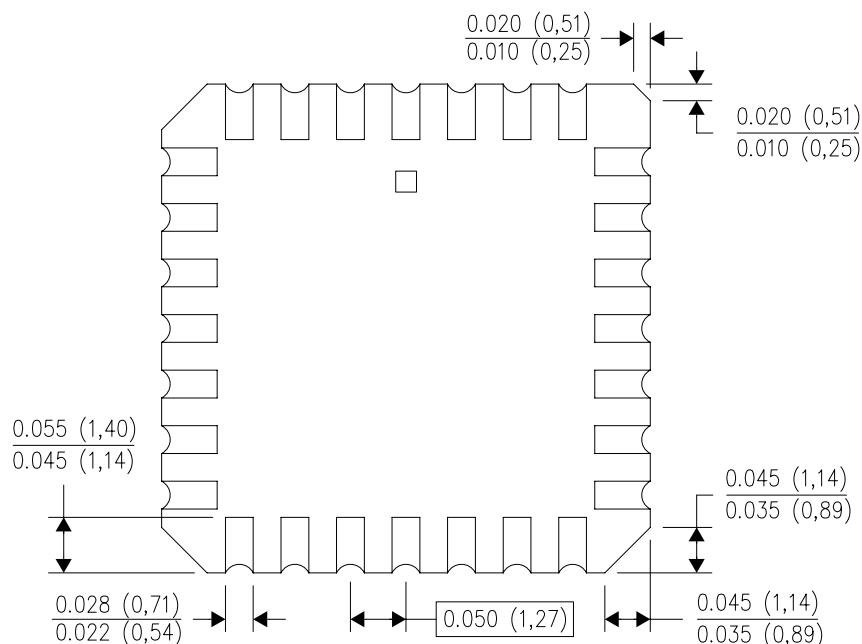
FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.740 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)

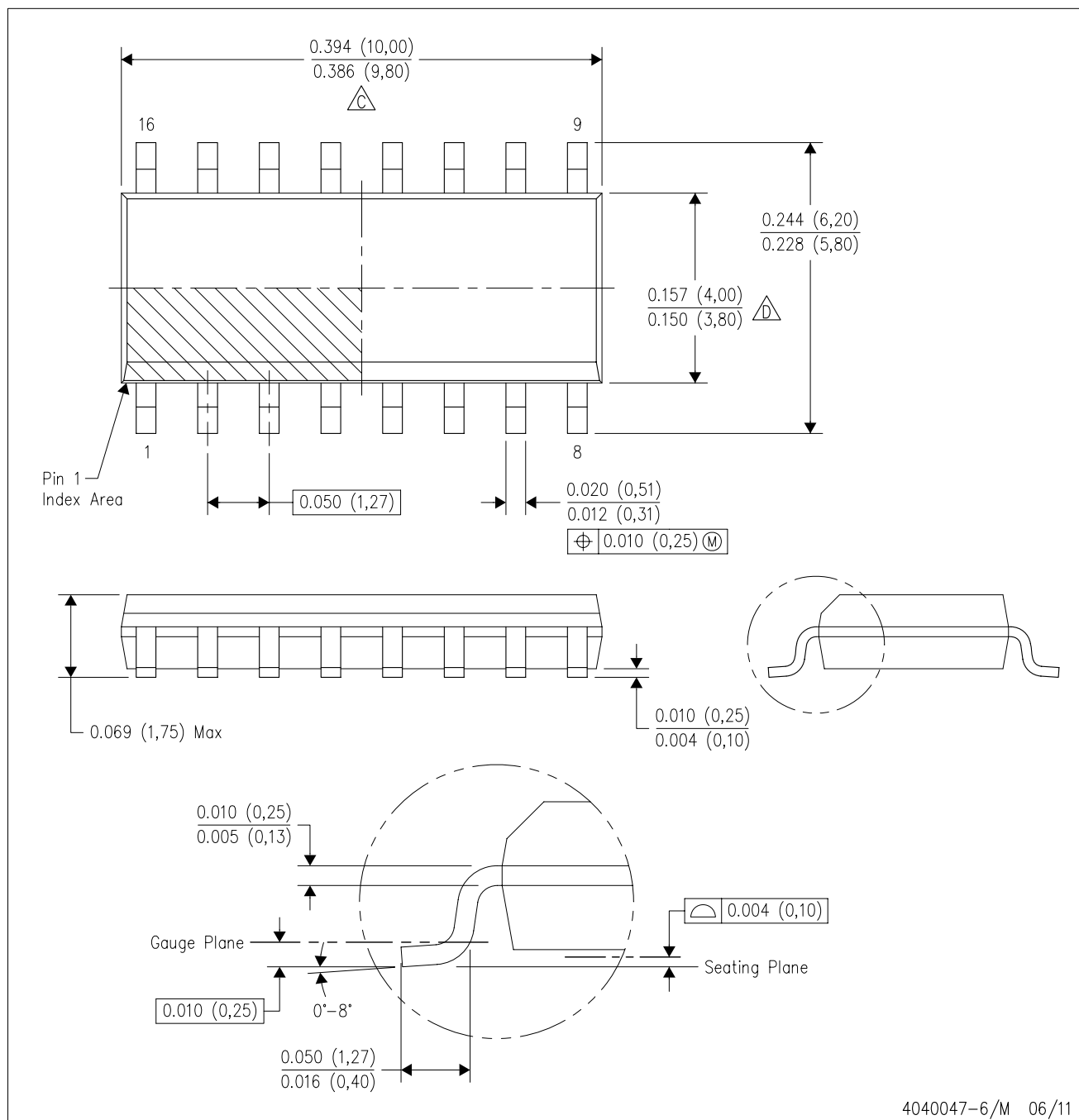


4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a metal lid.
 - Falls within JEDEC MS-004

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE

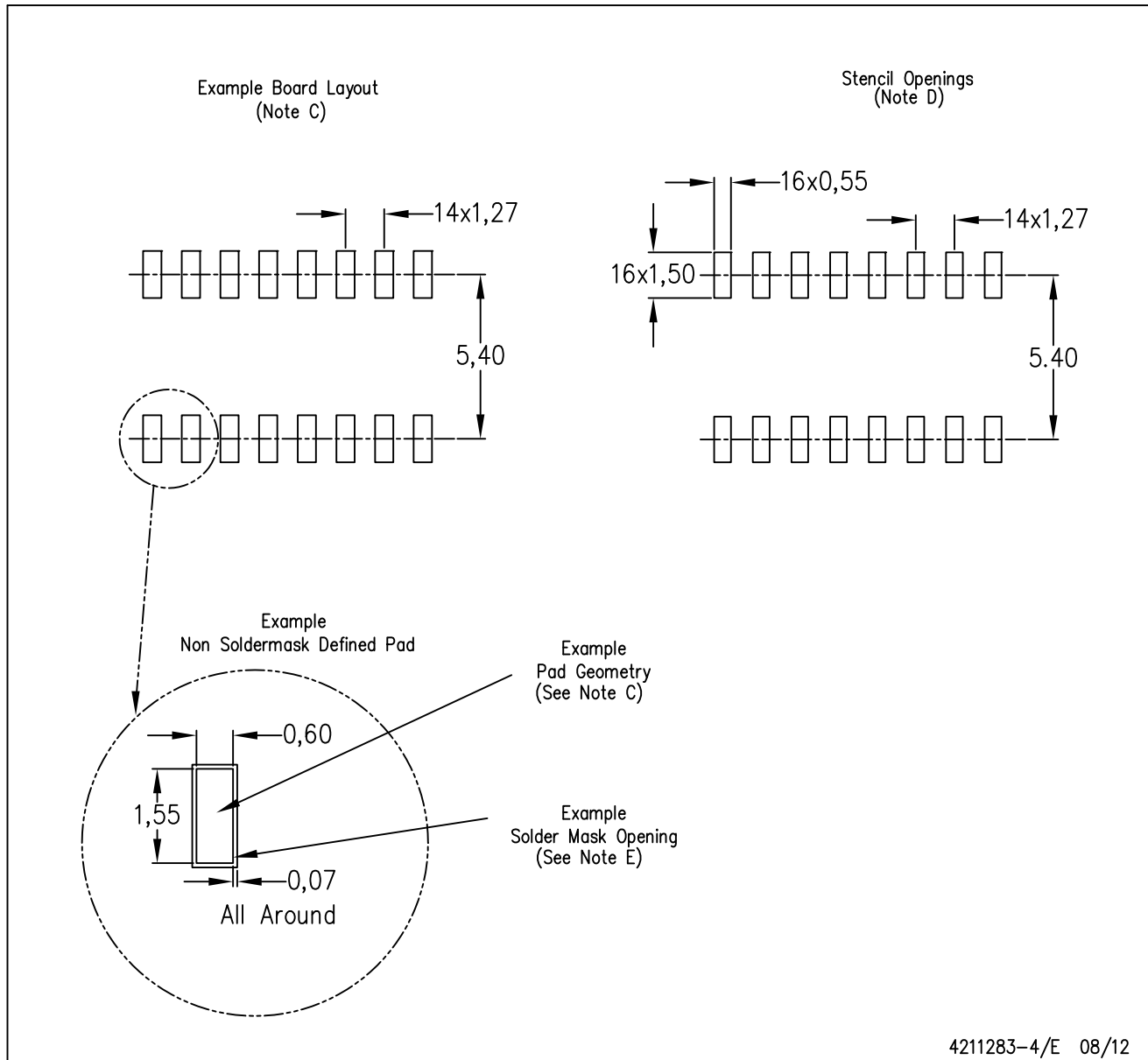


NOTES:

- A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
E. Reference JEDEC MS-012 variation AC.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



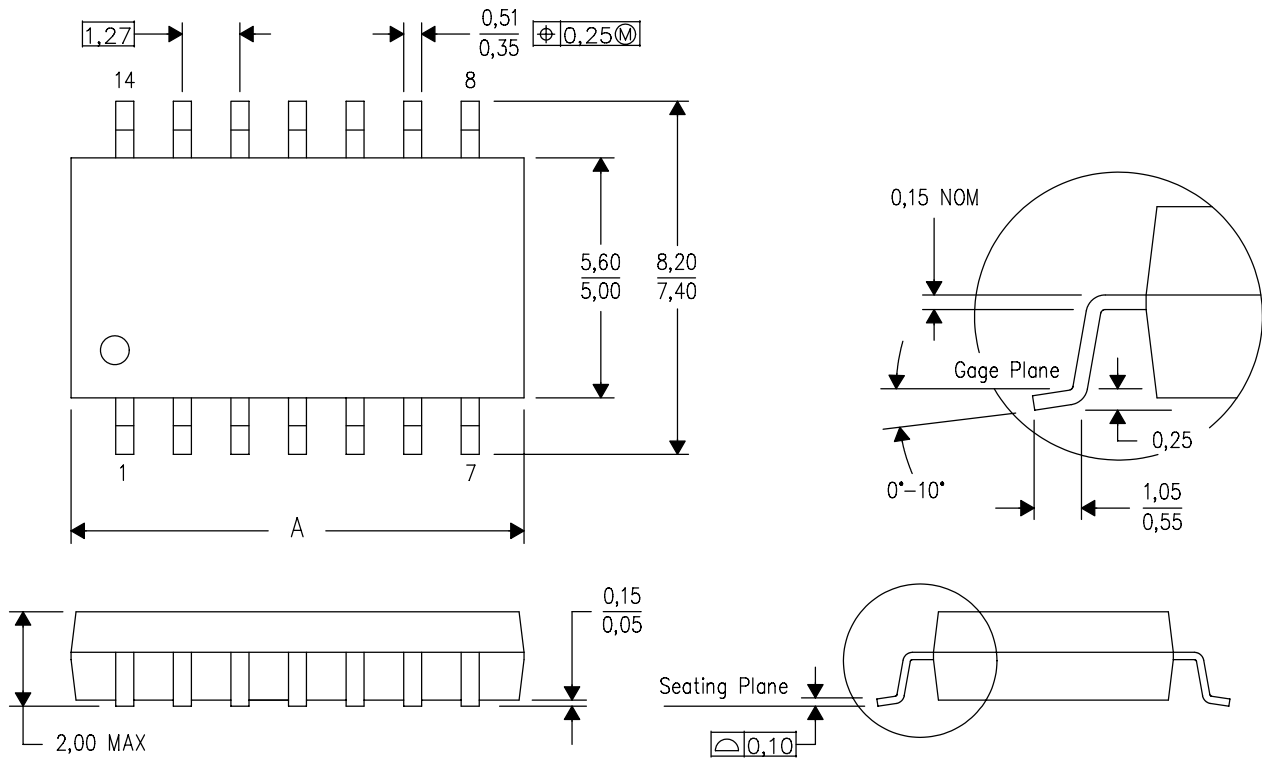
- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

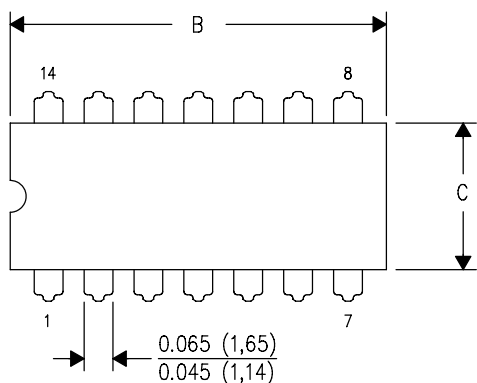
4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

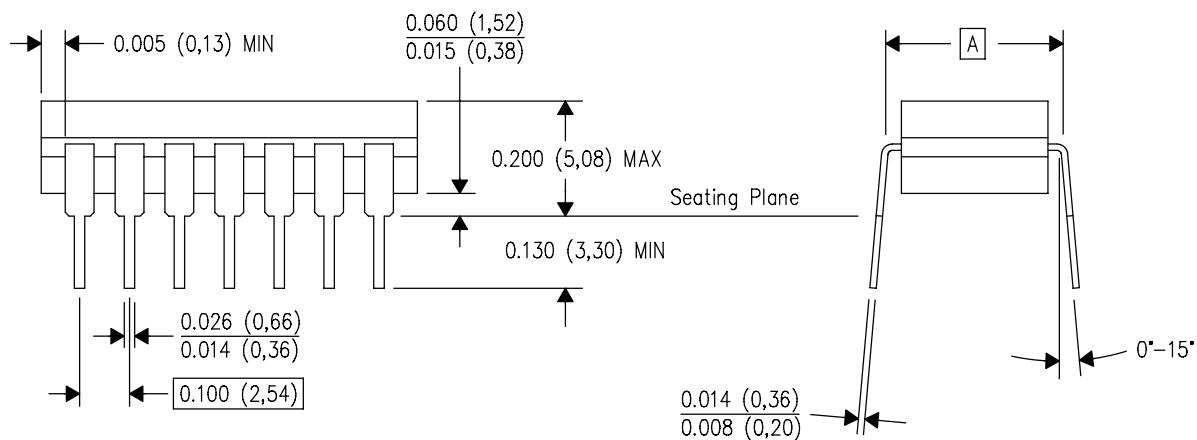
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



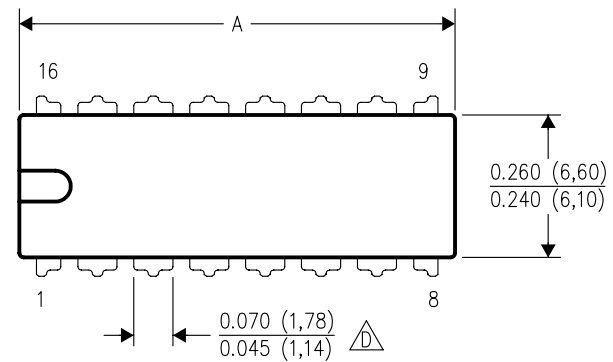
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

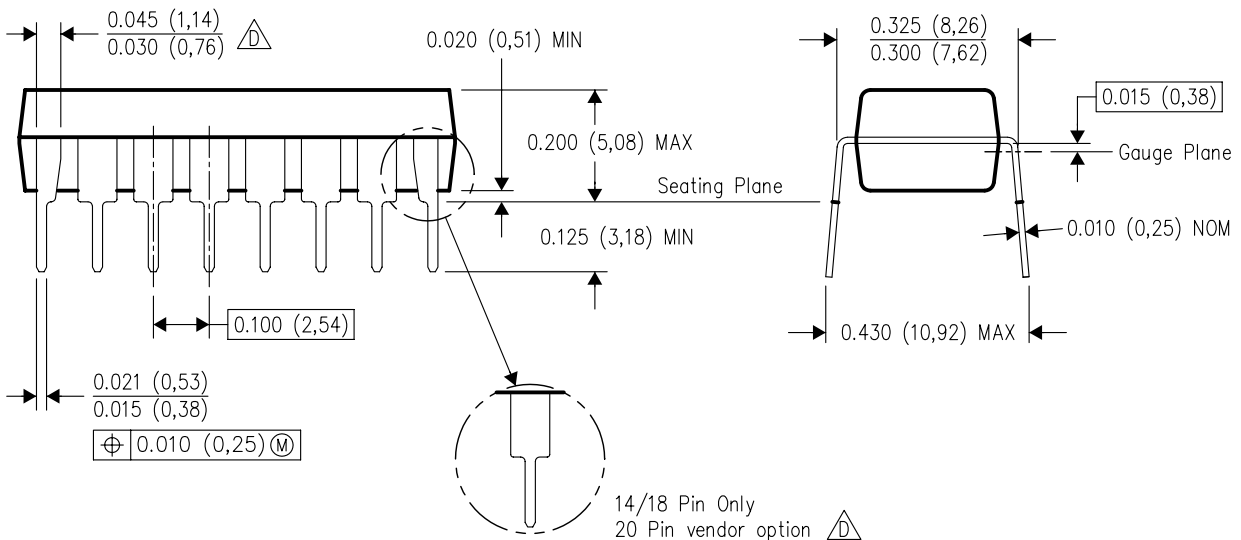
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE

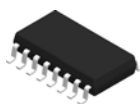


PINS **	14	16	18	20
DIM				
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - D The 20 pin end lead shoulder width is a vendor option, either half or full width.

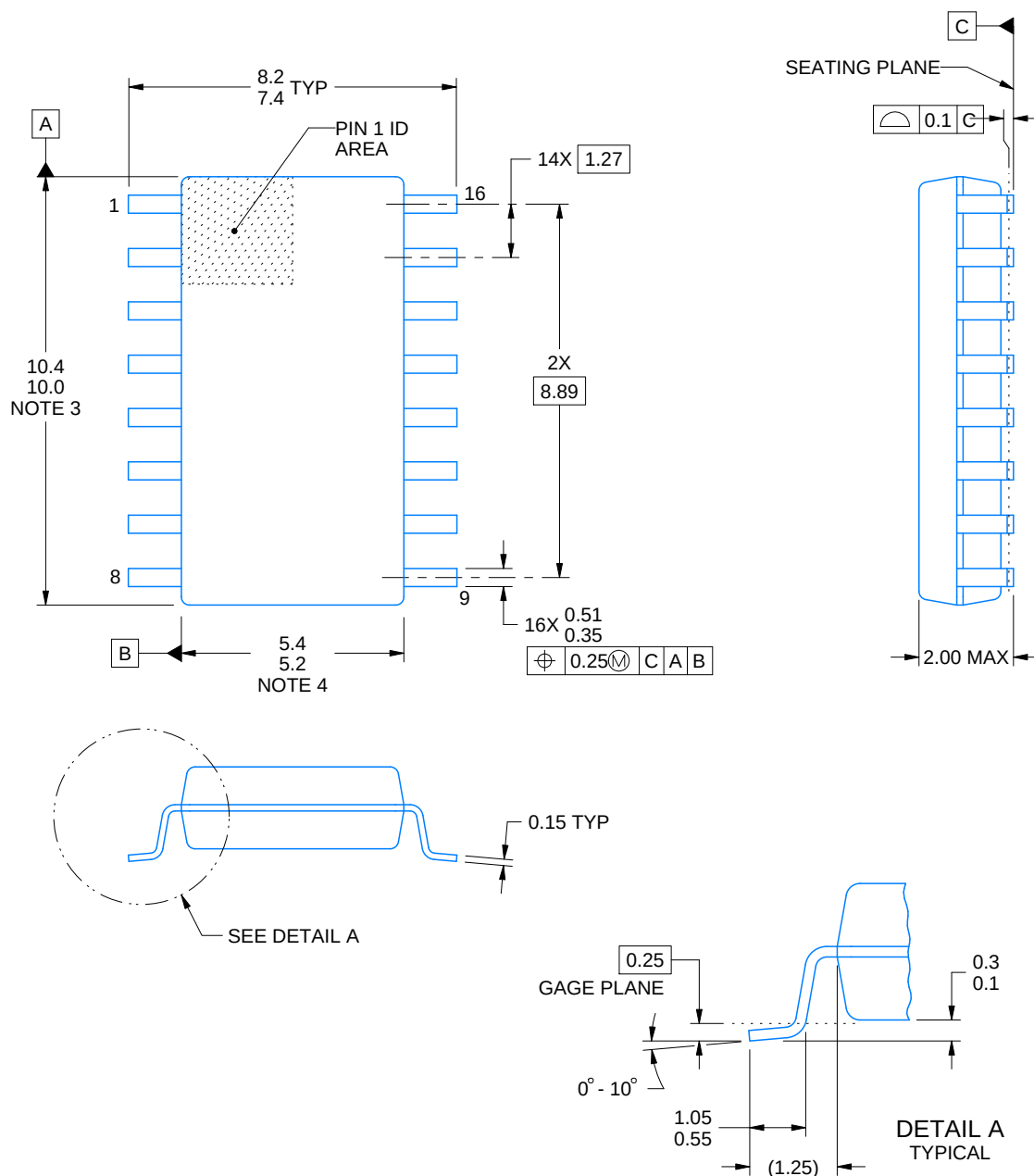


PACKAGE OUTLINE

NS0016A

SOP - 2.00 mm max height

SOP



4220735/A 12/2021

NOTES:

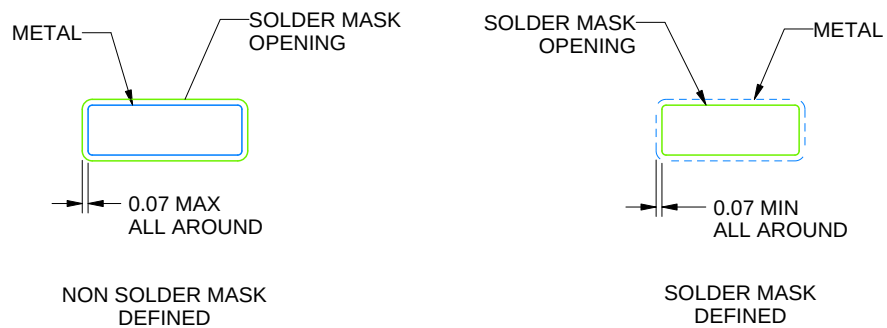
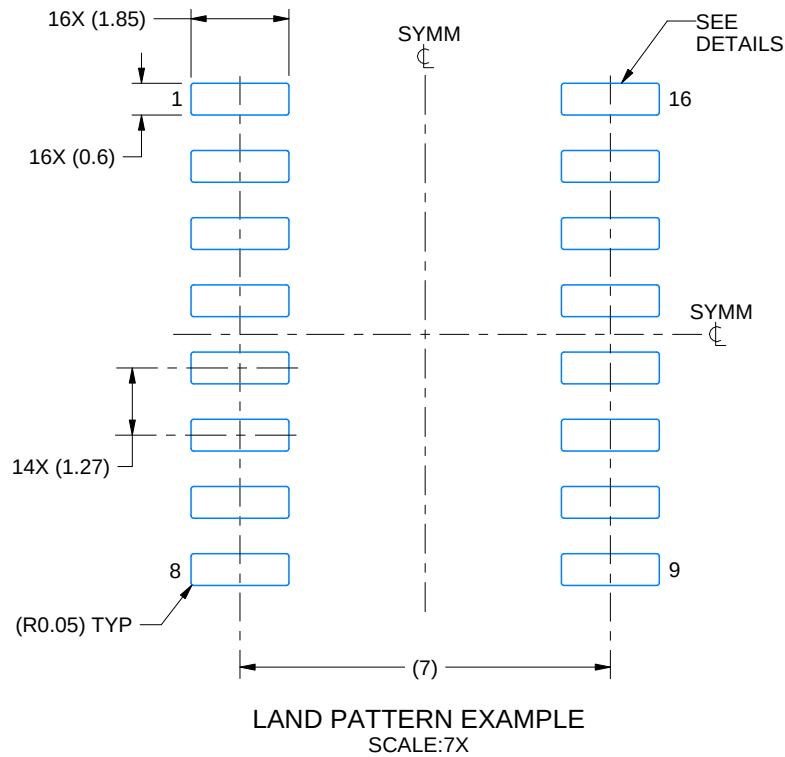
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.

EXAMPLE BOARD LAYOUT

NS0016A

SOP - 2.00 mm max height

SOP



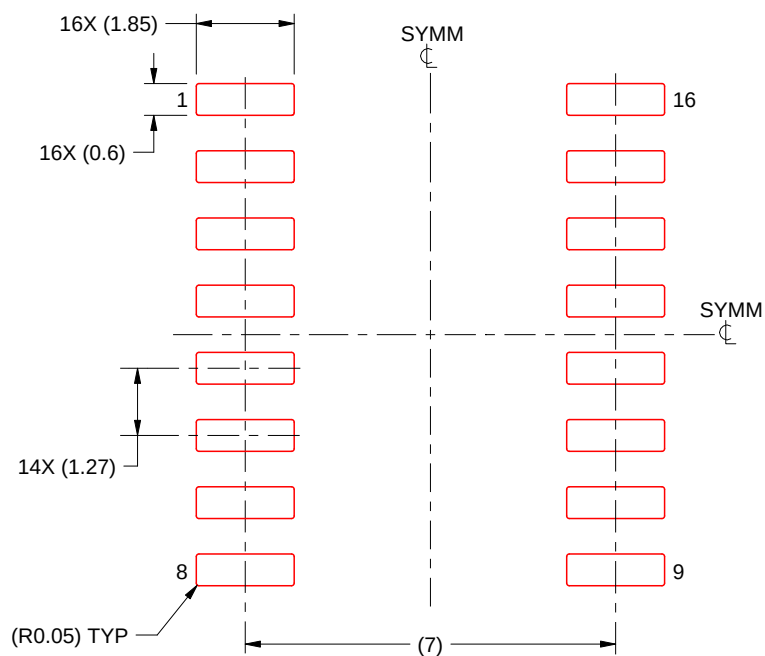
SOLDER MASK DETAILS

4220735/A 12/2021

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE
 BASED ON 0.125 mm THICK STENCIL
 SCALE:7X

4220735/A 12/2021

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](#) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2022, Texas Instruments Incorporated